



ISC Audits & Reviews SC Summary (June 22nd, 2026)

Doc.	Title	Results
7297A;	Revision to SEMI E137-0705 (Reapproved 0118)E, Guide For Final Assembly, Packaging, Transportation, Unpacking, And Relocation Of Semiconductor Manufacturing Equipment With Title Change To: Guide For Final Assembly, Packing, Transportation, Unpacking, And Moving Of Semiconductor Manufacturing Equipment	Passed
7315;	New Standard: Test Method for PV Modules Intensify Aging in Cold Environmental Conditions ;	Passed
7371B-LI1;	Addition to §10.2 of a minimum size criterion for symbols. ;	Passed
7380A-LI2;	Address issues raised by TF members;	Passed
7411A-LI1;	Revision of §15;	Passed
7419A-LI1;	Clarify StateMachineInstance usage;	Passed
7419A-LI2;	Update issues raised by TF members;	Passed
7420A-LI1;	Add Level 2 and 3 categories of etch information; and expand Definitions section to cover any new terms introduced in these categories;	Passed
7420A-LI2;	Add Related Information section to explain etch processing theory of operation;	Passed
7427-LI1;	Restrict WellKnownName field usage and add new CustomDescriptor field.;	Passed
7427-LI2;	Address gaps and issues raised by TF Members;	Passed
7446-LI1;	Reconciling SEMI S14 with SEMI S10;	Failed
7447-LI1;	Address issues with Well-Known Names;	Passed

For more information, please contact the SEMI Standards Engineer/Coordinator.
<http://www.semi.org/standards/contacts>) nearest you.

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 June 22nd, 2026